

IGBT MODULE (N series)

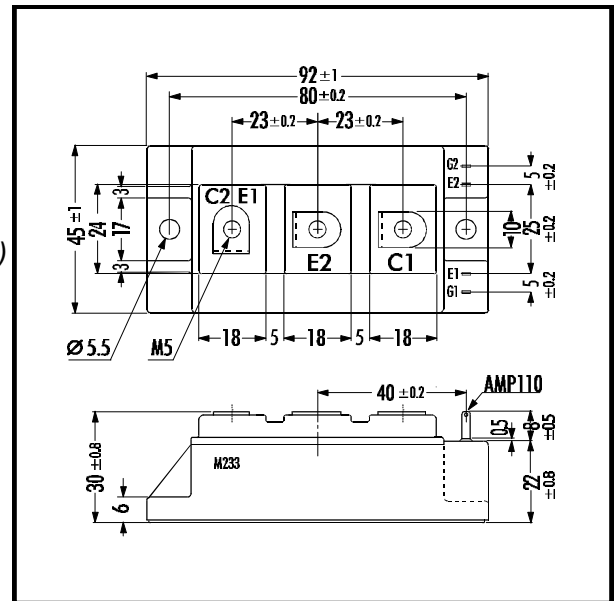
■ Features

- Square RBSOA
- Low Saturation Voltage
- Less Total Power Dissipation
- Improved FWD Characteristic
- Minimized Internal Stray Inductance
- Overcurrent Limiting Function (~3 Times Rated Current)

■ Applications

- High Power Switching
- A.C. Motor Controls
- D.C. Motor Controls
- Uninterruptible Power Supply

■ Outline Drawing



■ Maximum Ratings and Characteristics

• Absolute Maximum Ratings (T_c=25°C)

Items	Symbols	Rated Values	Units
Collector-Emitter Voltage	V _{CES}	600	V
Gate -Emitter Voltage	V _{GES}	± 20	V
Collector Current	Continuous	I _C	300
	1ms	I _{C PULSE}	600
	Continuous	-I _C	300
	1ms	-I _{C PULSE}	600
Max. Power Dissipation	P _C	1100	W
Operating Temperature	T _j	+150	°C
Storage Temperature	T _{stg}	-40 ~ +125	°C
Isolation Voltage	A.C. 1min.	V _{is}	2500
Screw Torque	Mounting *1	3.5	Nm
	Terminals *1	3.5	

Note: *1:Recommendable Value; 2.5 - 3.5 Nm (M5)

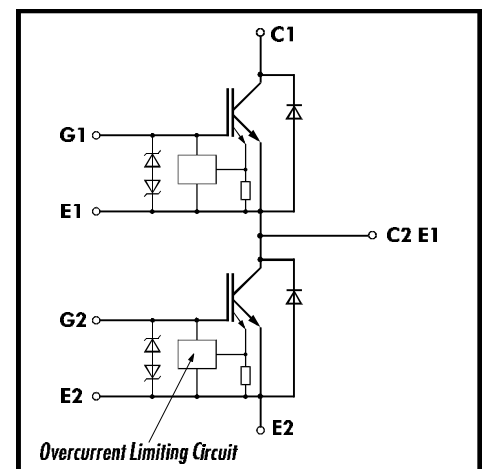
• Electrical Characteristics (at T_j=25°C)

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Zero Gate Voltage Collector Current	I _{CES}	V _{GE} =0V V _{CE} =600V			2.0	mA
Gate-Emitter Leakage Current	I _{GES}	V _{CE} =0V V _{GE} =± 20V			30	μA
Gate-Emitter Threshold Voltage	V _{GE(th)}	V _{GE} =20V I _C =300mA	4.5		7.5	V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} =15V I _C =300A			2.8	V
Input capacitance	C _{ies}	V _{GE} =0V		19800		pF
Output capacitance	C _{oes}	V _{CE} =10V		4400		
Reverse Transfer capacitance	C _{res}	f=1MHz		2000		
Turn-on Time	t _{ON}	V _{CC} =300V		0.6	1.2	μs
	t _r	I _C =300A		0.2	0.6	
Turn-off Time	t _{OFF}	V _{GE} =± 15V		0.6	1.0	
	t _f	R _G =6.8Ω		0.2	0.35	
Diode Forward On-Voltage	V _F	I _F =300A V _{GE} =0V			3.0	V
Reverse Recovery Time	t _{rr}	I _F =300A			300	ns

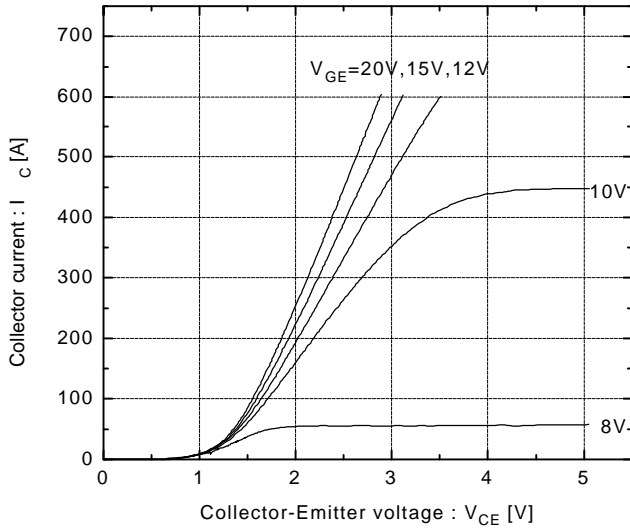
• Thermal Characteristics

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance	R _{th(j-c)}	IGBT			0.11	°C/W
	R _{th(j-e)}	Diode			0.24	
	R _{th(c-f)}	With Thermal Compound		0.025		

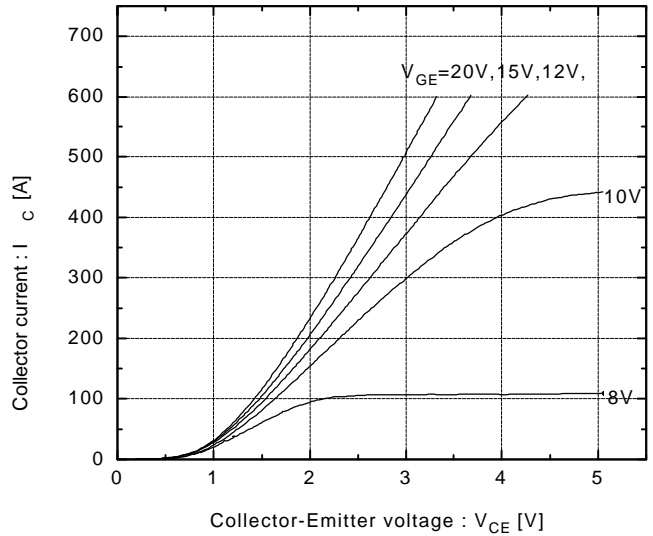
■ Equivalent Circuit



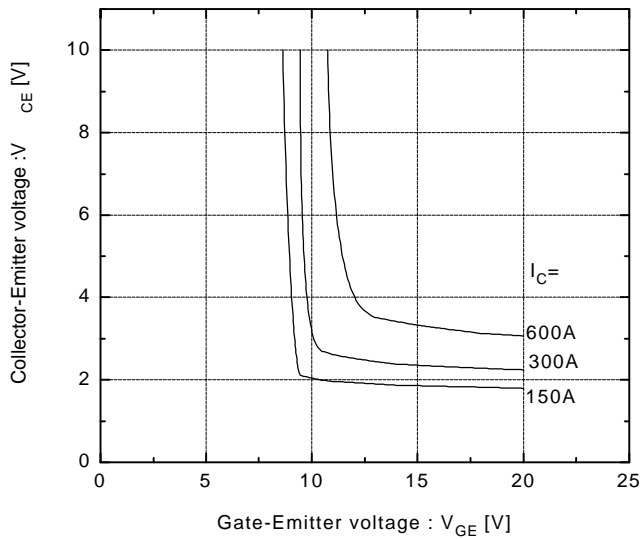
Collector current vs. Collector-Emmitter voltage
 $T_j=25^\circ\text{C}$



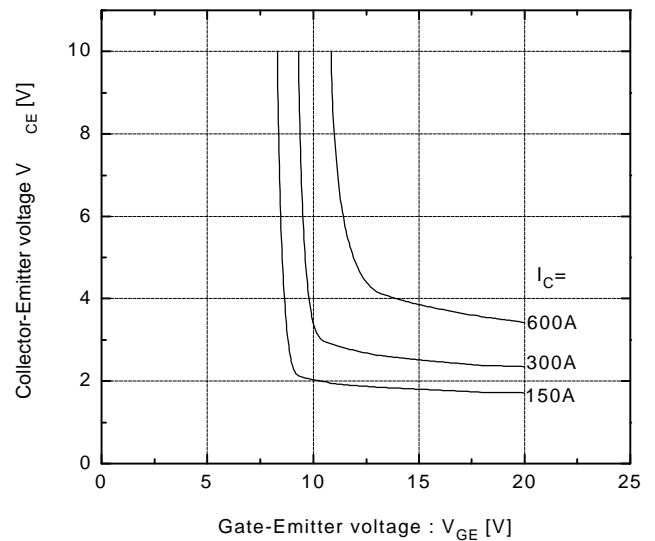
Collector current vs. Collector-Emmitter voltage
 $T_j=125^\circ\text{C}$



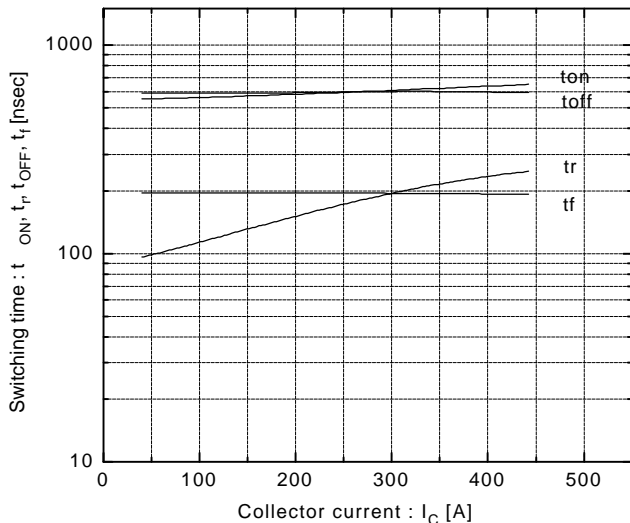
Collector-Emmitter vs. Gate-Emmitter voltage
 $T_j=25^\circ\text{C}$



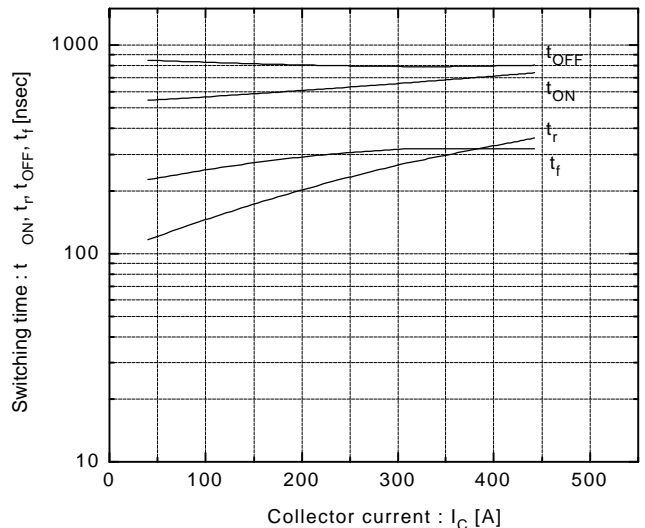
Collector-Emmitter vs. Gate-Emmitter voltage
 $T_j=125^\circ\text{C}$



Switching time vs. Collector current
 $V_{CC}=300\text{V}, R_G=6.8\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$

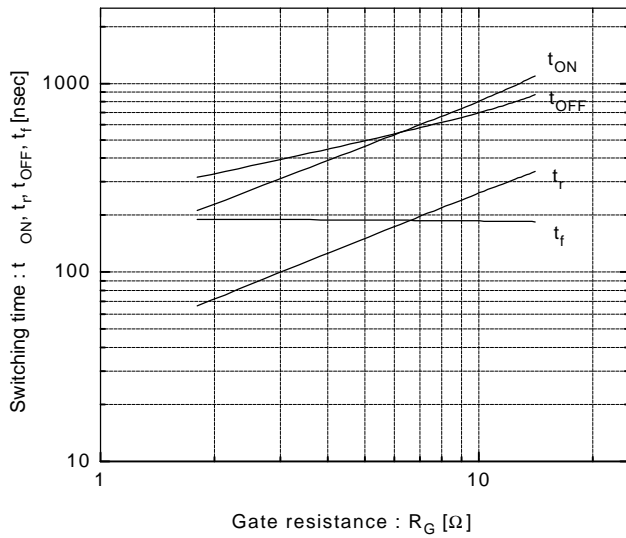


Switching time vs. Collector current
 $V_{CC}=300\text{V}, R_G=6.8\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$



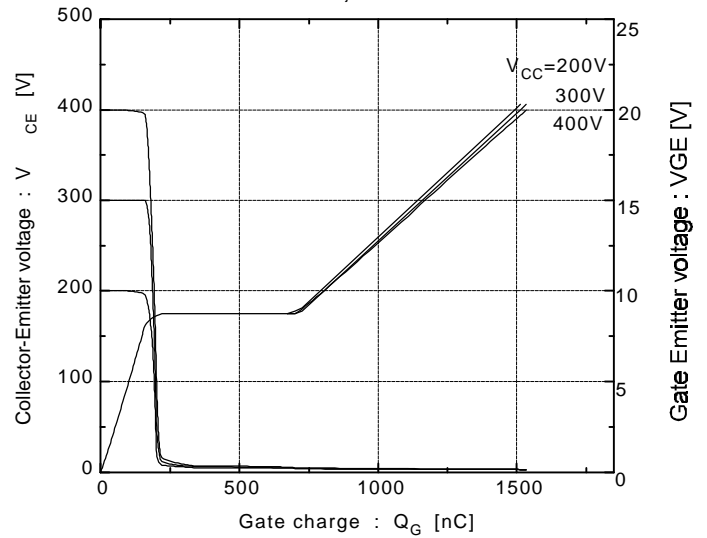
Switching time vs. R_G

$V_{CC}=300V, I_C=300A, V_{GE}=\pm 15V, T_J=25^\circ C$



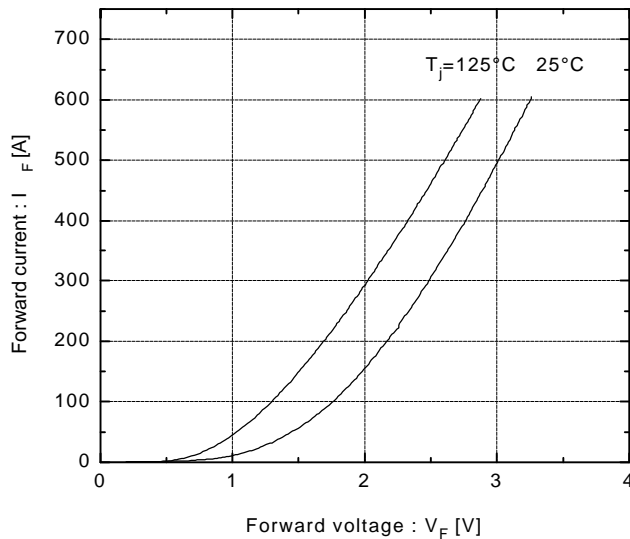
Dynamic input characteristics

$T_J=25^\circ C$



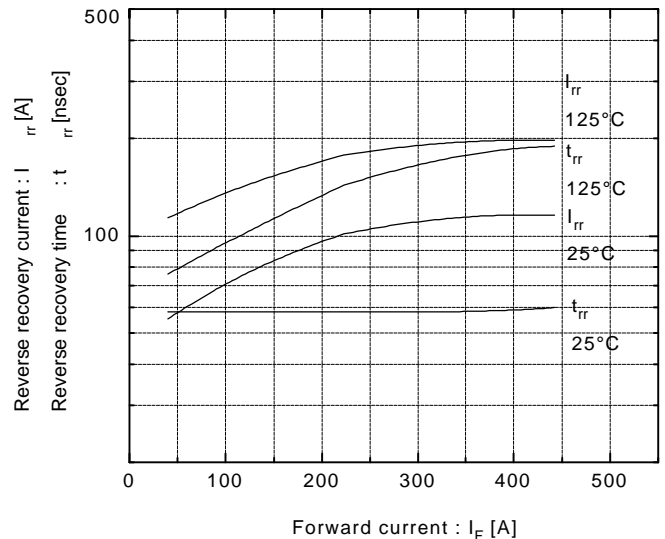
Forward current vs. Forward voltage

$V_{GE}=0V$

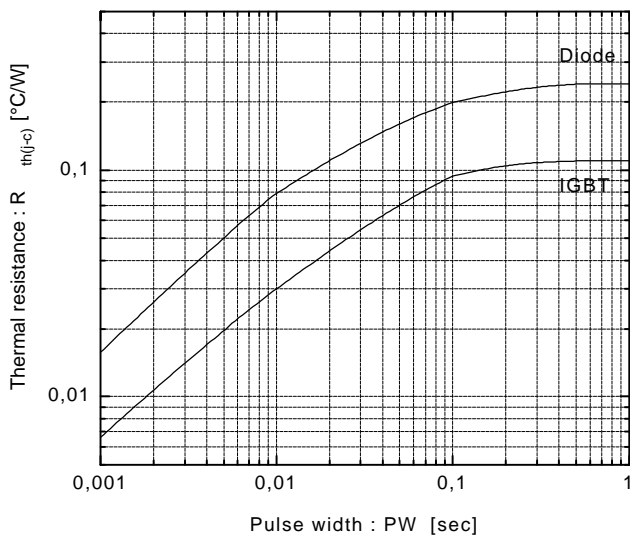


Reverse recovery characteristics

t_{rr}, I_{rr} vs. I_F

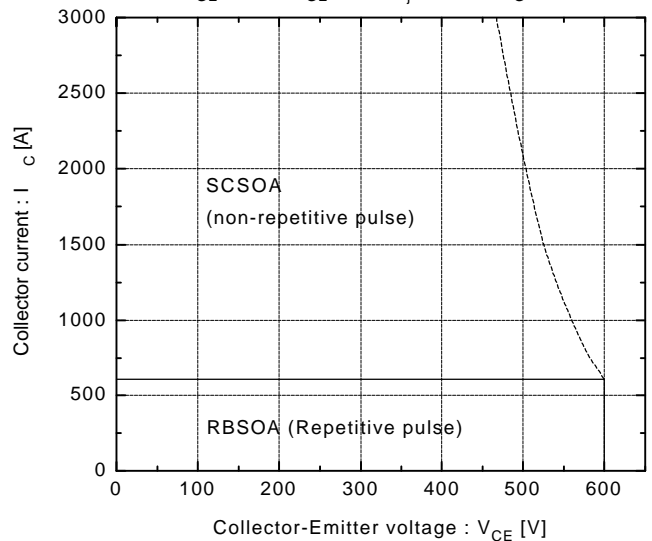


Transient thermal resistance

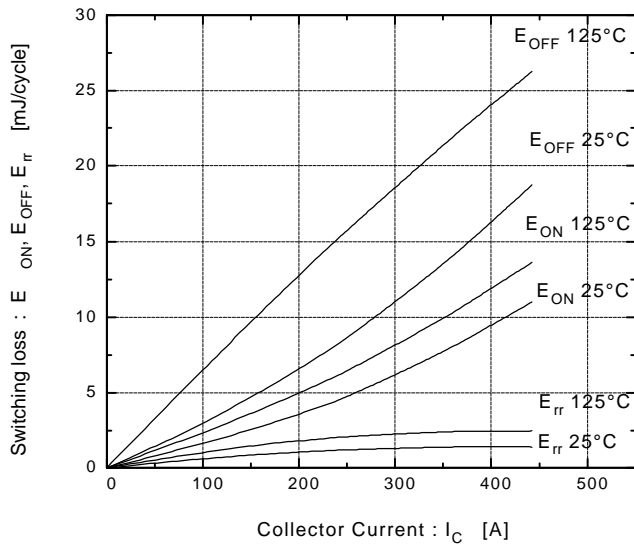


Reversed biased safe operating area

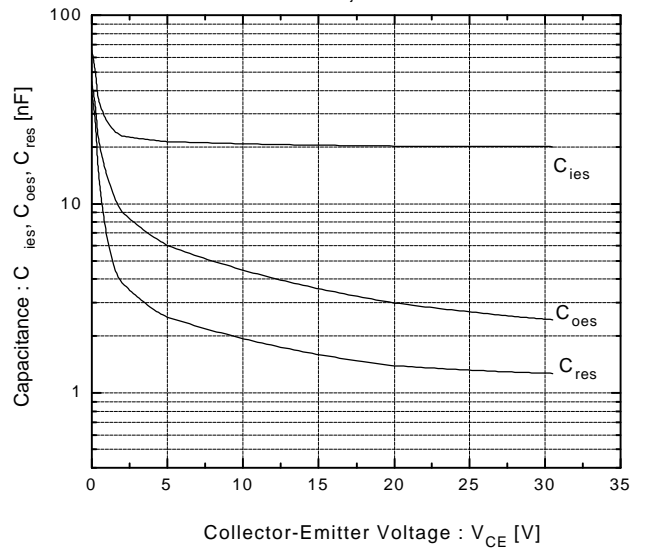
$+V_{GE}=15V, -V_{GE}\leq 15V, T_J\leq 125^\circ C, R_G\geq 6.8\Omega$



Switching loss vs. Collector current
 $V_{CC}=300V, R_G=6.8\Omega, V_{GE}=\pm 15V$



Capacitance vs. Collector-Emitter voltage
 $T_J=25^\circ C$



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